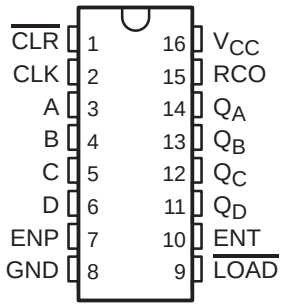
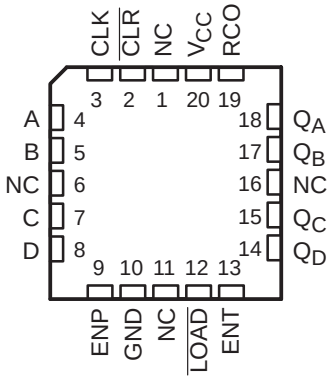
- **Internal Look-Ahead Circuitry for Fast Counting**
- **Carry Output for n-Bit Cascading**
- **Synchronous Counting**
- **Synchronously Programmable**
- **Package Options Include Plastic Small-Outline (D) and Shrink Small-Outline (DB) Packages, Ceramic Chip Carriers (FK), Standard Plastic (N) and Ceramic (J) DIPs**

SN54ALS161B, SN54ALS162B, SN54ALS163B, SN54AS161, SN54AS163 . . . J PACKAGE
SN74ALS161B, SN74AS161, SN74AS163 . . . D OR N PACKAGE
SN74ALS163B . . . D, DB, OR N PACKAGE
(TOP VIEW)



SN54ALS161B, SN54ALS162B, SN54ALS163B, SN54AS161, SN54AS163 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

These synchronous, presettable, 4-bit decade and binary counters feature an internal carry look-ahead circuitry for application in high-speed counting designs. The SN54ALS162B is a 4-bit decade counter. The ’ALS161B, ’ALS163B, ’AS161, and ’AS163 devices are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincidentally with each other when instructed by the count-enable (ENP, ENT) inputs and internal gating. This mode of operation eliminates the output counting spikes normally associated with asynchronous (ripple-clock) counters. A buffered clock (CLK) input triggers the four flip-flops on the rising (positive-going) edge of the clock input waveform.

These counters are fully programmable; they can be preset to any number between 0 and 9 or 15. Because presetting is synchronous, setting up a low level at the load ($\overline{\text{LOAD}}$) input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs.

The clear function for the ’ALS161B and ’AS161 devices is asynchronous. A low level at the clear ($\overline{\text{CLR}}$) input sets all four of the flip-flop outputs low, regardless of the levels of the CLK, $\overline{\text{LOAD}}$, or enable inputs. The clear function for the SN54ALS162B, ’ALS163B, and ’AS163 devices is synchronous, and a low level at $\overline{\text{CLR}}$ sets all four of the flip-flop outputs low after the next clock pulse, regardless of the levels of the enable inputs. This synchronous clear allows the count length to be modified easily by decoding the Q outputs for the maximum count desired. The active-low output of the gate used for decoding is connected to $\overline{\text{CLR}}$ to synchronously clear the counter to 0000 (LLLL).

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. ENP and ENT inputs and a ripple-carry (RCO) output are instrumental in accomplishing this function. Both ENP and ENT must be high to count, and ENT is fed forward to enable RCO. RCO, thus enabled,

description (continued)

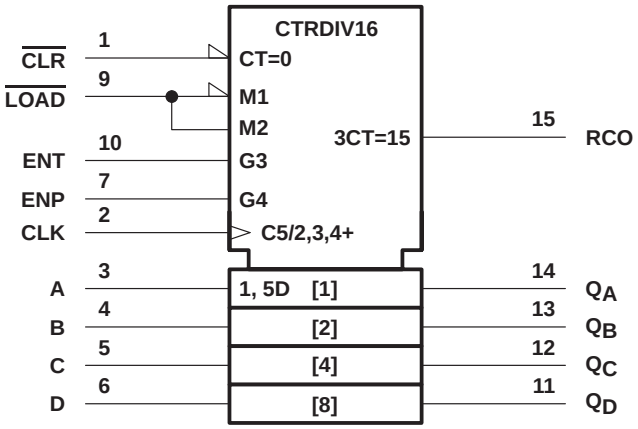
produces a high-level pulse while the count is maximum (9 or 15, with Q_A high). The high-level overflow ripple-carry pulse can be used to enable successive cascaded stages. Transitions at ENP or ENT are allowed, regardless of the level of CLK.

These counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or $\overline{\text{LOAD}}$) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) is dictated solely by the conditions meeting the stable setup and hold times.

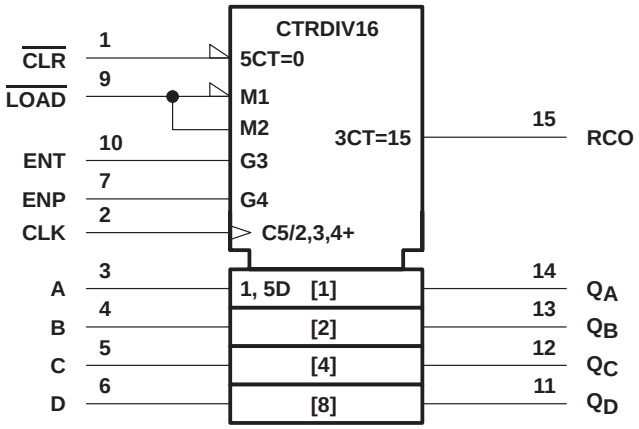
The SN54ALS161B, SN54ALS162B, SN54ALS163B, SN54AS161, and SN54AS163 are characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ALS161B, SN74ALS163B, SN74AS161, and SN74AS163 are characterized for operation from 0°C to 70°C.

logic symbols†

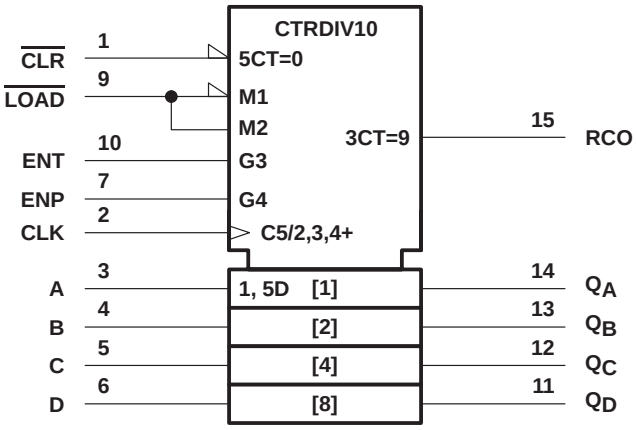
'ALS161B AND 'AS161 BINARY COUNTERS WITH DIRECT CLEAR



'ALS163B AND 'AS163 BINARY COUNTERS WITH SYNCHRONOUS CLEAR

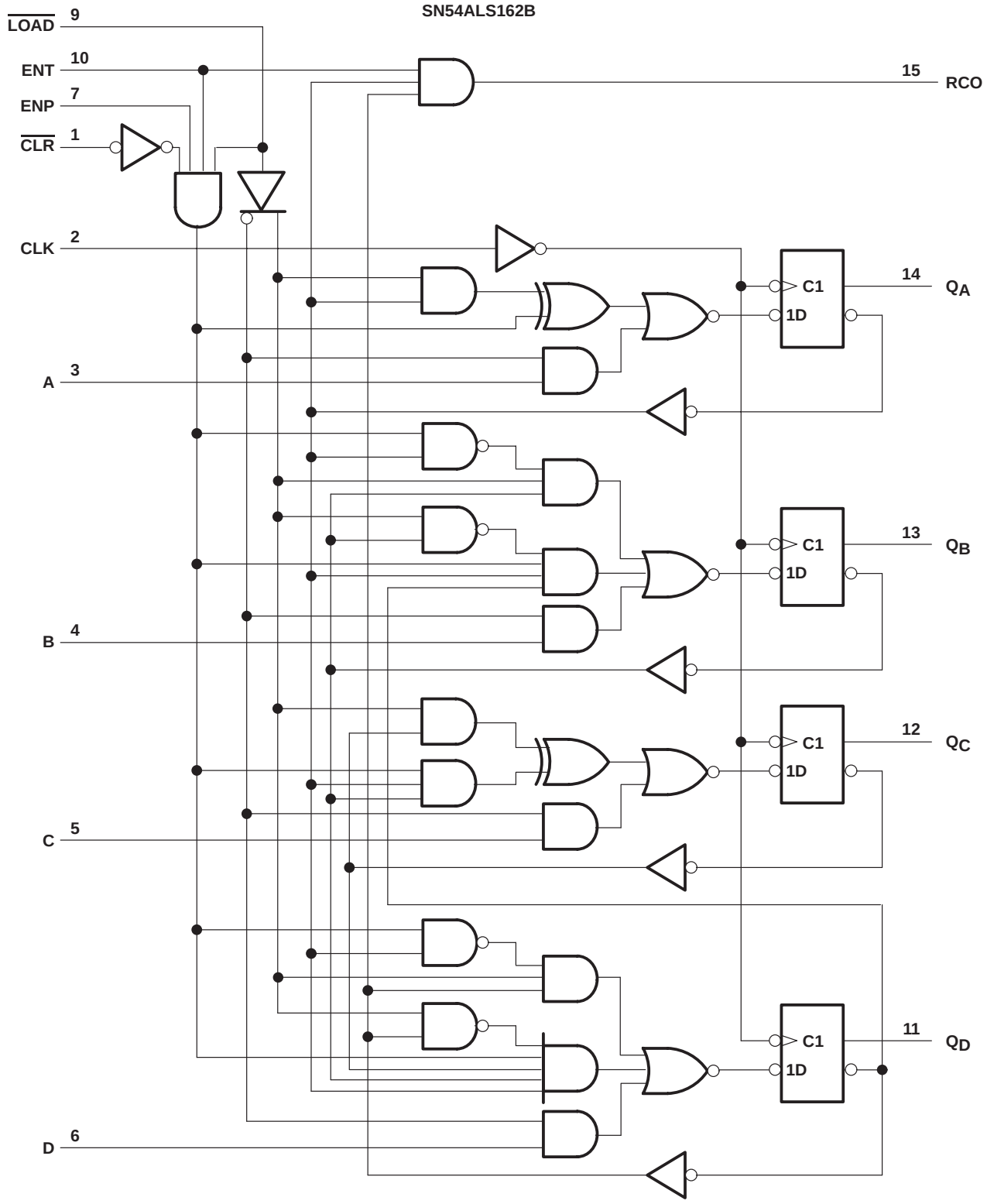


SN54ALS162B DECADE COUNTER WITH SYNCHRONOUS CLEAR



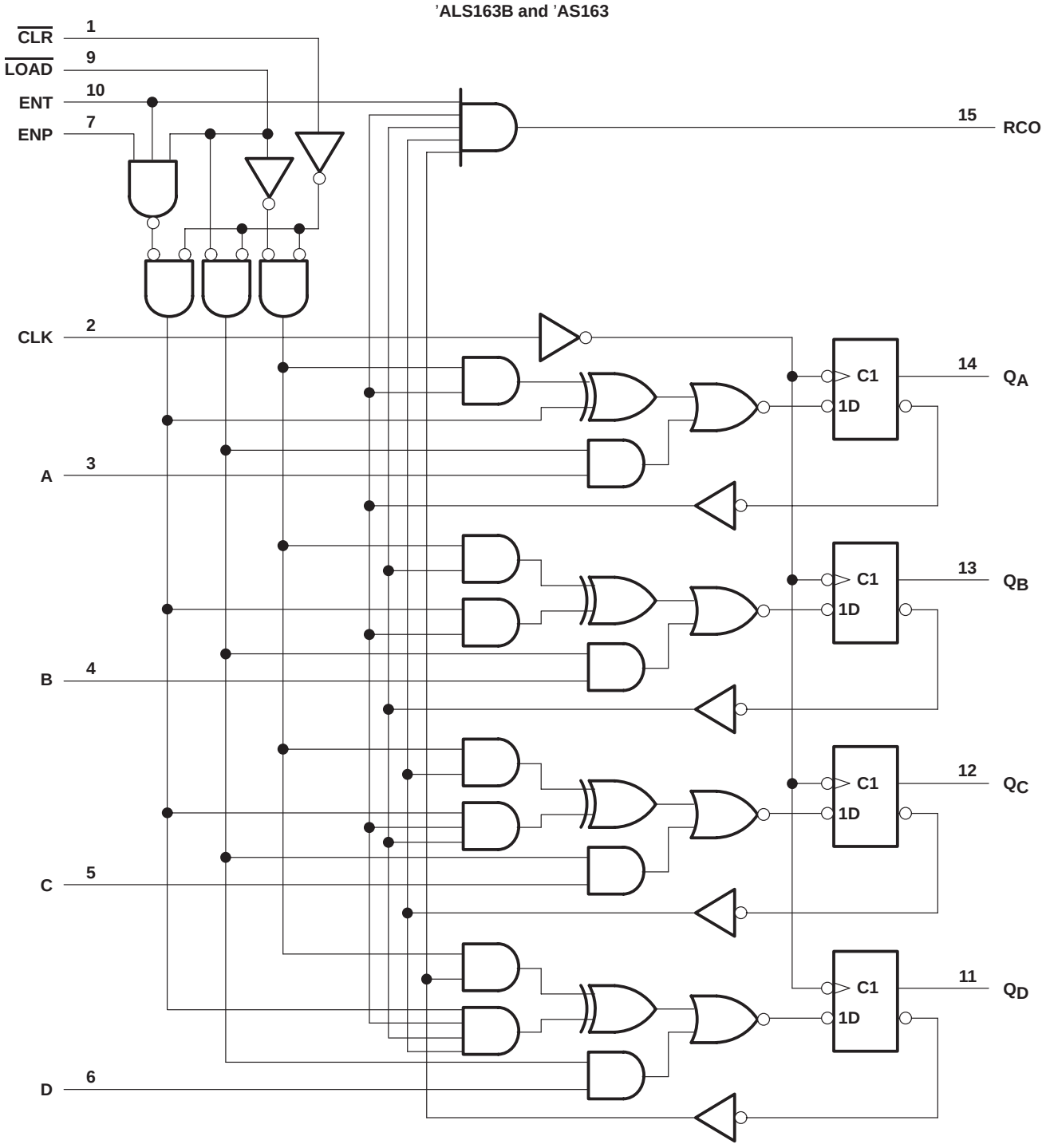
† These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, DB, J, and N packages.

logic diagram (positive logic)



Pin numbers shown are for the J package.

logic diagram (positive logic)



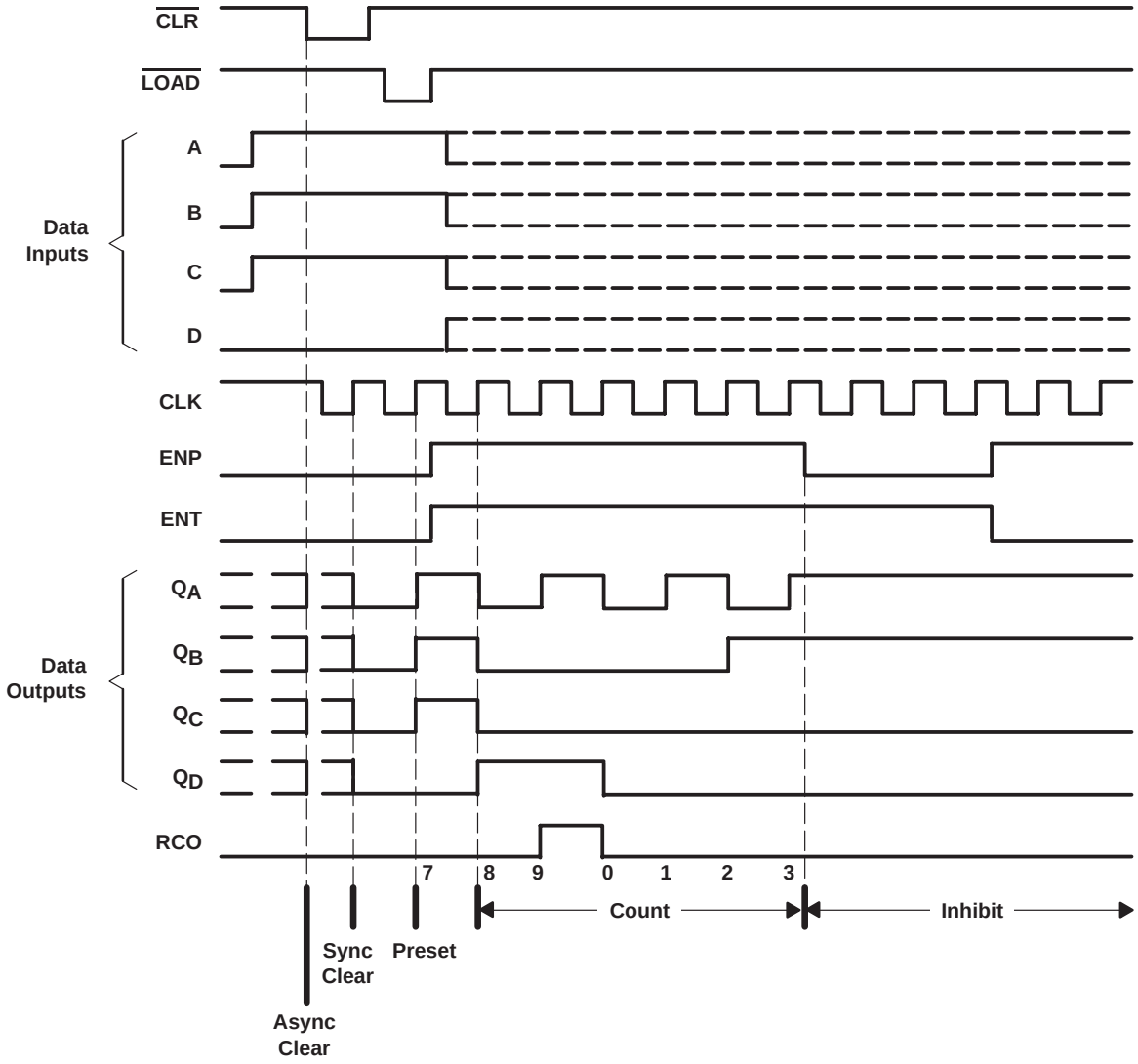
Pin numbers shown are for the D, DB, J, and N packages.
'ALS161B and 'AS161 synchronous binary counters are similar; however, $\overline{\text{CLR}}$ is asynchronous.

typical clear, preset, count, and inhibit sequences

SN54ALS162B

The following sequence is illustrated below:

1. Clear outputs to zero (SN54ALS162B is synchronous)
2. Preset to BCD 7
3. Count to 8, 9, 0, 1, 2, and 3
4. Inhibit

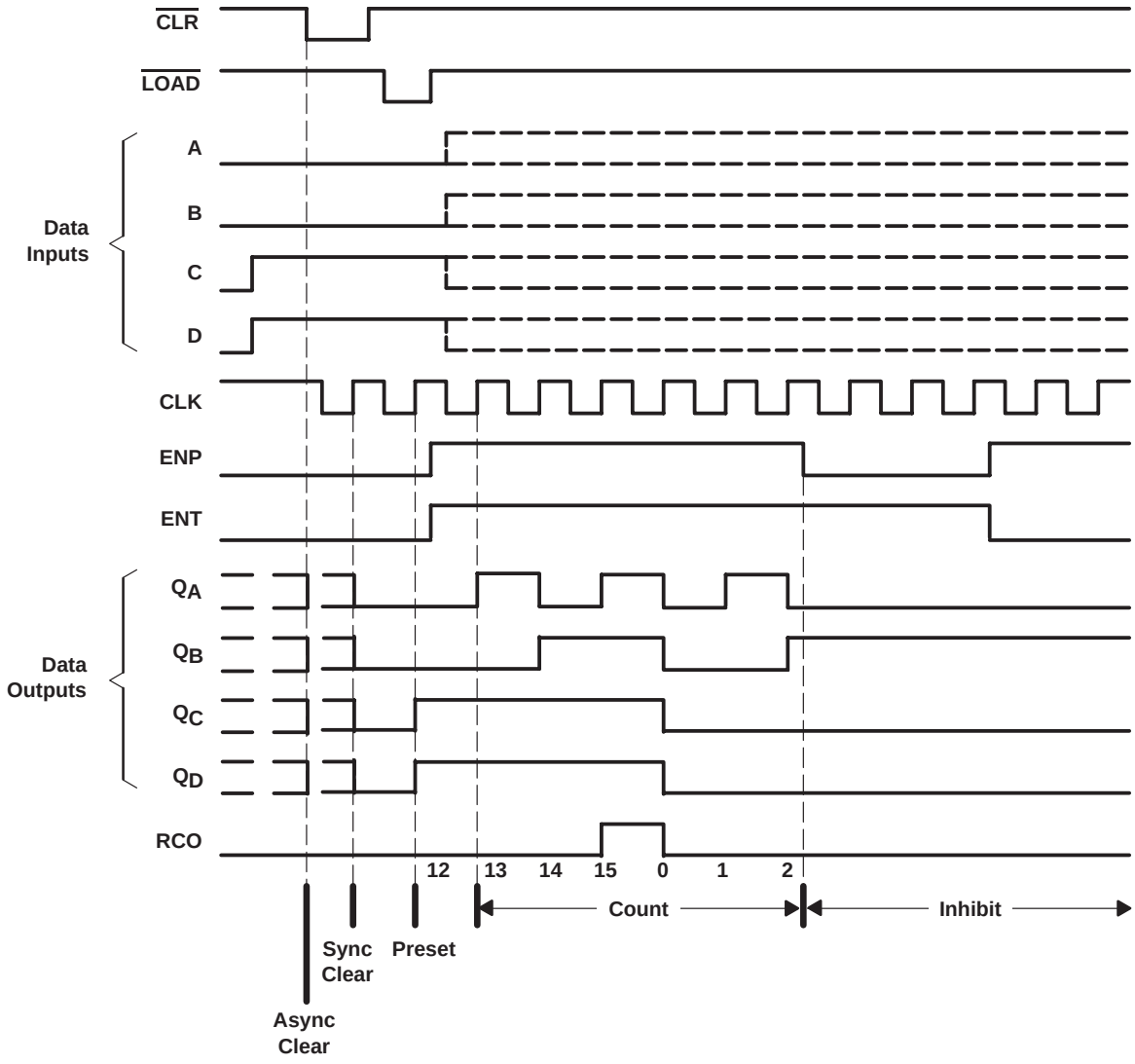


typical clear, preset, count, and inhibit sequences

'ALS161B, 'AS161, 'ALS163B, and 'AS163

The following sequence is illustrated below:

1. Clear outputs to zero ('ALS161B and 'AS161 are asynchronous; 'ALS163B and 'AS163 are synchronous.)
2. Preset to binary 12
3. Count to 13, 14, 15, 0, 1, and 2
4. Inhibit



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . –0.5 V to 7 V
Input voltage range, V_I . . . . . –0.5 V to 7 V
Package thermal impedance, θ_{JA} (see Note 1): D package . . . . . 73°C/W
DB package . . . . . 82°C/W
N package . . . . . 67°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions

		SN54ALS161B SN54ALS162B SN54ALS163B			SN74ALS161B SN74ALS163B			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.7			0.8	V
I_{OH}	High-level output current			–0.4			–0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS161B SN54ALS162B SN54ALS163B			SN74ALS161B SN74ALS163B			UNIT
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = –18 mA			–1.5			–1.5	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –0.4 mA	V_{CC} –2			V_{CC} –2			V
V_{OL}	V_{CC} = 4.5 V	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 8 mA					0.35	0.5	
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			–0.2			–0.2	mA
I_O§	V_{CC} = 5.5 V,	V_O = 2.25 V	–20		–112	–30		–112	mA
I_{CC}	V_{CC} = 5.5 V			12	21		12	21	mA

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS}.

timing requirements over recommended operating conditions (unless otherwise noted) (see Figure 1)

				SN54ALS161B SN54ALS162B SN54ALS163B		SN74ALS161B SN74ALS163B		UNIT
				MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency				22		40	MHz
t_w	Pulse duration	$\overline{CLR}$ high or low		20		12.5		ns
		'ALS161B	$\overline{CLR}$ low	20		15		
t_{su}	Setup time, before CLK↑	A, B, C, D		50		15		ns
		$\overline{LOAD}$		20		15		
		'ALS161B	ENP, ENT	25		15		
		SN54ALS162B, 'ALS163B		20		15		
		'ALS161B	$\overline{CLR}$ inactive	10		10		
		SN54ALS162B, 'ALS163B	$\overline{CLR}$ low	20		15		
			$\overline{CLR}$ high	20		10		
t_h	Hold time, all synchronous inputs after CLK↑			0		0		ns

switching characteristics over recommended operating conditions (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALS161B		SN74ALS161B		UNIT
			MIN	MAX	MIN	MAX	
f_{max}			22		40		MHz
t_{PLH}	CLK	RCO	5	34	5	20	ns
t_{PHL}			5	27	5	20	
t_{PLH}	CLK	Any Q	4	19	4	15	ns
t_{PHL}			6	25	6	20	
t_{PLH}	ENT	RCO	3	18	3	13	ns
t_{PHL}			3	17	3	13	
t_{PHL}	$\overline{CLR}$	Any Q	8	27	8	24	ns
		RCO	11	32	11	23	

switching characteristics over recommended operating conditions (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ALS162B SN54ALS163B		SN74ALS163B		UNIT
			MIN	MAX	MIN	MAX	
f_{max}			22		40		MHz
t_{PLH}	CLK	RCO	5	25	5	20	ns
t_{PHL}			5	25	5	20	
t_{PLH}	CLK	Any Q	4	18	4	15	ns
t_{PHL}			6	25	6	20	
t_{PLH}	ENT	RCO	3	16	3	13	ns
t_{PHL}			3	16	3	13	

recommended operating conditions

		SN54AS161 SN54AS163			SN74AS161 SN74AS163			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–2			–2	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54AS161 SN54AS163			SN74AS161 SN74AS163			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		V_{CC} = 4.5 V,	I_I = –18 mA			–1.2			–1.2	V
V_{OH}		V_{CC} = 4.5 V to 5.5 V,	I_{OH} = –2 mA	V_{CC} –2			V_{CC} –2			V
V_{OL}		V_{CC} = 4.5 V,	I_{OL} = 20 mA		0.25	0.5		0.25	0.5	V
I_I	$\overline{LOAD}$	V_{CC} = 5.5 V,	V_I = 7 V			0.3			0.3	mA
	ENT					0.2			0.2	
	All others					0.1			0.1	
I_{IH}	$\overline{LOAD}$	V_{CC} = 5.5 V,	V_I = 2.7 V			60			60	µA
	ENT					40			40	
	All others					20			20	
I_{IL}	$\overline{LOAD}$	V_{CC} = 5.5 V,	V_I = 0.4 V			–1.5			–1.5	mA
	ENT					–1			–1	
	All others					–0.5			–0.5	
I_O‡		V_{CC} = 5.5 V,	V_O = 2.25 V	–30		–112	–30		–112	mA
I_{CC}		V_{CC} = 5.5 V			35	53		35	53	mA

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

timing requirements over recommended operating conditions (see Figure 1)

				SN54AS161 SN54AS163		SN74AS161 SN74AS163		UNIT
				MIN	MAX	MIN	MAX	
f_{clock}	Clock frequency				65		75	MHz
t_w	Pulse duration	$\overline{CLR}$ high or low		7.7		6.7		ns
		'AS161	$\overline{CLR}$ low	10		8		
t_{su}	Setup time, before CLK↑	A, B, C, D		10		8		ns
		$\overline{LOAD}$		10		8		
		ENP, ENT		10		8		
		'AS161	$\overline{CLR}$ inactive	10		8		
		'AS163	$\overline{CLR}$ low	14		12		
			$\overline{CLR}$ high (inactive)	10		9		
t_h	Hold time, all synchronous inputs after CLK↑			2		0		ns

switching characteristics over recommended operating conditions (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54AS161		SN74AS161		UNIT
			MIN	MAX	MIN	MAX	
f_{max}			65*		75		MHz
t_{PLH}	CLK	RCO (with $\overline{LOAD}$ high)	1	8.5	1	8	ns
		RCO (with $\overline{LOAD}$ low)	3	17.5	3	16.5	
t_{PHL}	CLK	RCO	2	14	2	12.5	ns
t_{PLH}	CLK	Any Q	1	7.5	1	7	ns
t_{PHL}			2	14	2	13	
t_{PLH}	ENT	RCO	1.5	10	1.5	9	ns
t_{PHL}			1	9.5	1	8.5	
t_{PHL}	$\overline{CLR}$	Any Q	2	14	2	13	ns
		RCO	2	14	2	12.5	

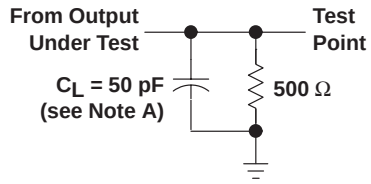
* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating conditions (see Figure 1)

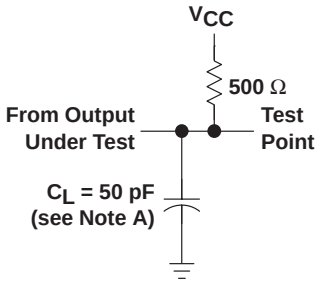
PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54AS163		SN74AS163		UNIT
			MIN	MAX	MIN	MAX	
f_{max}			65*		75		MHz
t_{PLH}	CLK	RCO (with $\overline{LOAD}$ high)	1	8.5	1	8	ns
		RCO (with $\overline{LOAD}$ low)	3	17.5	3	16.5	
t_{PHL}	CLK	RCO	2	14	2	12.5	ns
t_{PLH}	CLK	Any Q	1	7.5	1	7	ns
t_{PHL}			2	14	2	13	
t_{PLH}	ENT	RCO	1.5	10	1.5	9	ns
t_{PHL}			1	9.5	1	8.5	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

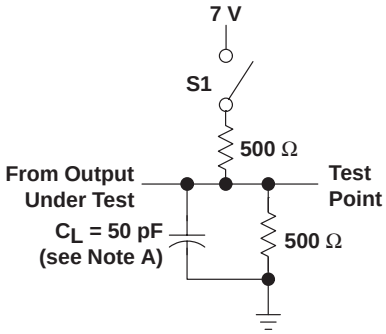
PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



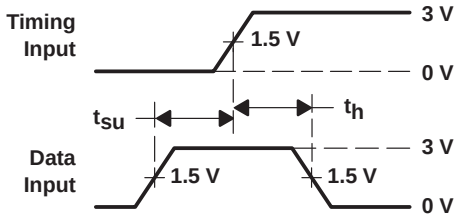
LOAD CIRCUIT FOR
BI-STATE TOTEM-POLE OUTPUTS



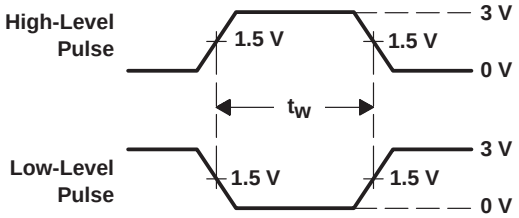
LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS



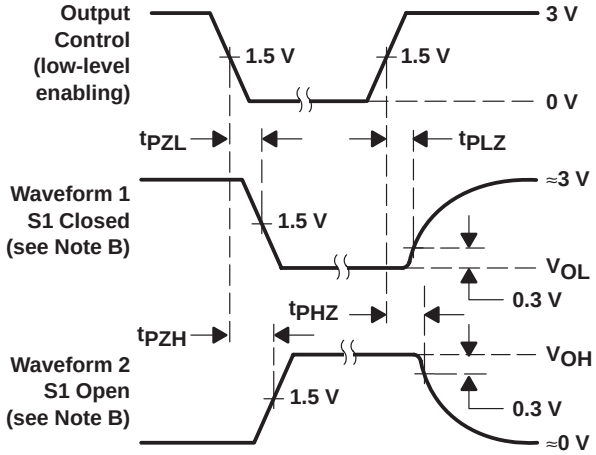
LOAD CIRCUIT
FOR 3-STATE OUTPUTS



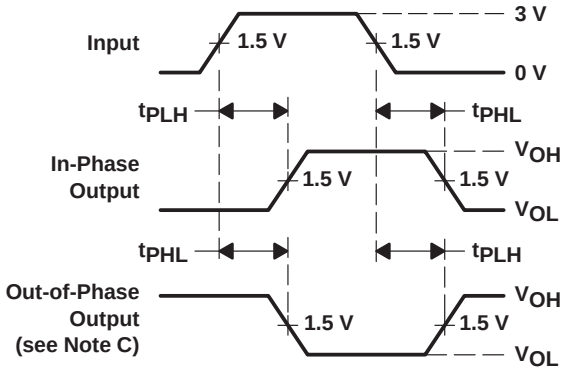
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES

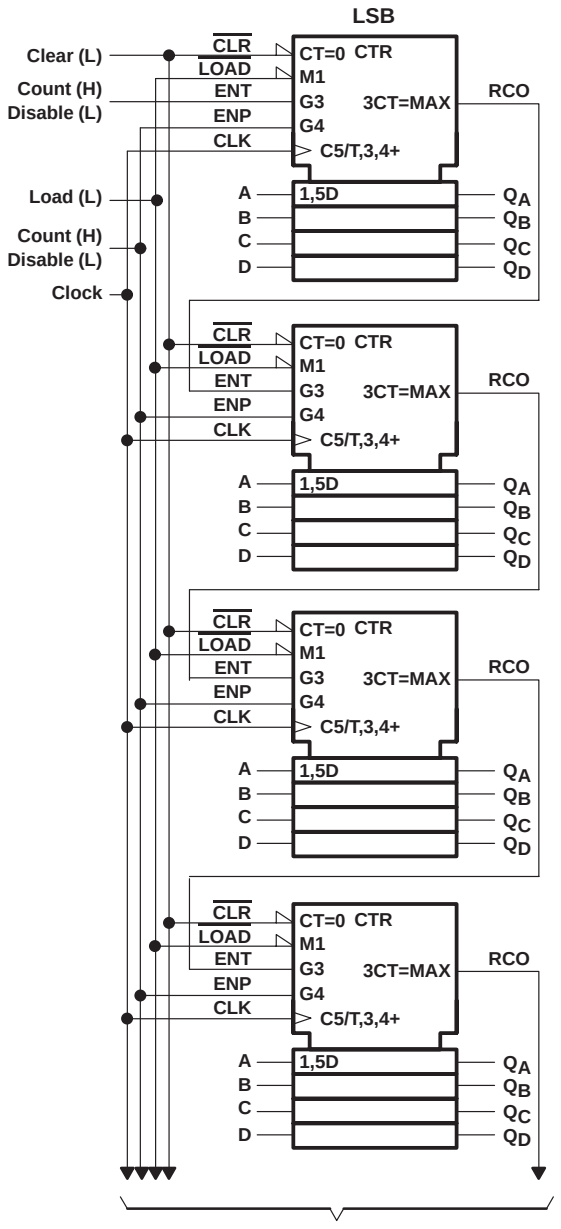
NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f$ = 2 ns, duty cycle = 50%.
E. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

APPLICATION INFORMATION

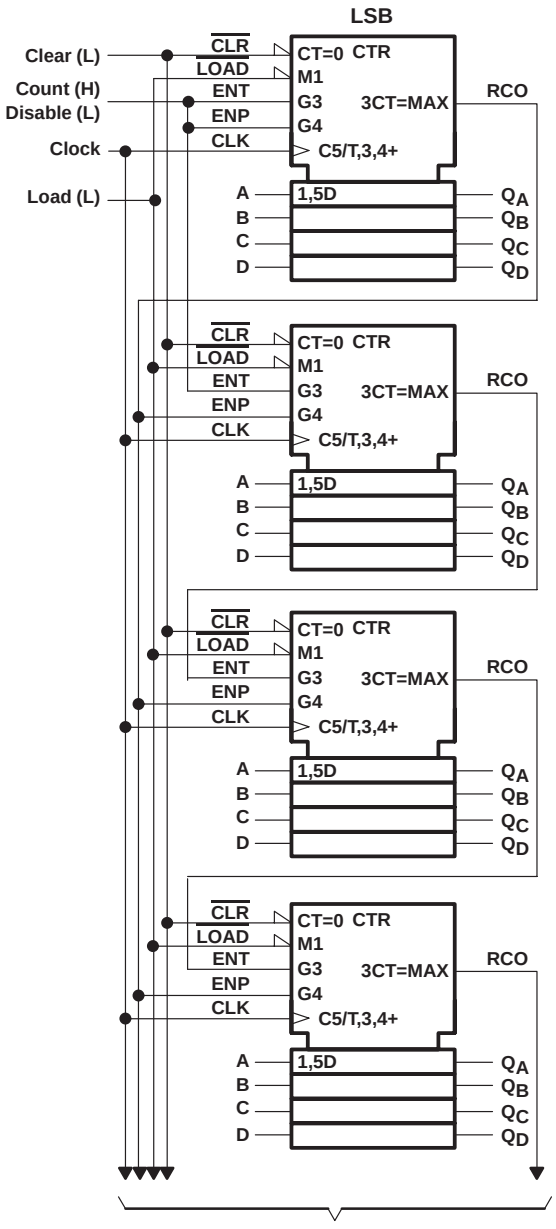
n-bit synchronous counters

This application demonstrates how the ripple-mode carry circuit (see Figure 2) and the carry look-ahead circuit (see Figure 3) can be used to implement a high-speed n-bit counter. The SN54ALS162B counts in BCD. The 'ALS161B, 'AS161, 'ALS163B, and 'AS163 devices count in binary. When additional stages are added, the f_{max} decreases in Figure 2, but remains unchanged in Figure 3.



$f_{max} = 1/(\text{CLK to RCO } t_{PLH}) + (\text{ENT to RCO } t_{PLH})\ (N - 2) + (\text{ENT } t_{su})$

Figure 2. Ripple-Mode Carry Circuit



$f_{max} = 1/(\text{CLK to RCO } t_{PLH}) + (\text{ENP } t_{su})$

Figure 3. Carry Look-Ahead Circuit

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
83022012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
8302201EA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
8302201FA	ACTIVE	CFP	W	16	1	None	Call TI	Level-NC-NC-NC
83022022A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
8302202EA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
8302202FA	OBSOLETE	CFP	W	16		None	Call TI	Call TI
JM38510/38001B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/38001BEA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
JM38510/38002B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/38002BEA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54ALS161BJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54ALS163BJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54AS161J	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54AS163J	OBSOLETE	CDIP	J	16		None	Call TI	Call TI
SN74ALS161BD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS161BDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS161BN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS161BN3	OBSOLETE	PDIP	N	16		None	Call TI	Call TI
SN74ALS161BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS163BD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS163BDBR	ACTIVE	SSOP	DB	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS163BDR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS163BN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS163BN3	OBSOLETE	PDIP	N	16		None	Call TI	Call TI
SN74ALS163BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS161D	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS161DR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS161N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS161NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS163D	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS163DR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS163N	ACTIVE	PDIP	N	16	25	Pb-Free	CU NIPDAU	Level-NC-NC-NC

Orderable Device	Status [1]	Package Type	Package Drawing	Pins	Package Qty	Eco Plan [2]	Lead/Ball Finish	MSL Peak Temp [3]
						(RoHS)		
SN74AS163NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS161BFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS161BJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS161BW	ACTIVE	CFP	W	16	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS163BFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS163BJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SNJ54AS161FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS161J	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SNJ54AS163J	OBSOLETE	CDIP	J	16		None	Call TI	Call TI

[1] The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
None: Not yet available Lead (Pb-Free).
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

[3] MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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